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Designed for: Public Release		Mod. Date: 12/09/2014	
Project Title: High Voltage Current Sense		Number: TIDA-00332	
Sheet Title: INA138 High Voltage Schematic		Rev: E1	Rev: E1
Assembly Variant: [No Variations]		SVN Rev: Not in version control	
File: 340V_INA138_ANSI-B.SchDoc		Sheet: 2 of 3	
Contact: http://www.ti.com/support		Size: B	
Engineer: Ed Mullins		http://www.ti.com	
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PCB Number: TIDA-00332
PCB Rev: E1

PCB
LOGO
Texas Instruments

Label Table	
Variant	Label Text
001	ChangeMe!
002	ChangeMe!

LBL1
PCB Label
Size: 0.65" x 0.20 "


ZZ1
Label Assembly Note
This Assembly Note is for PCB labels only

ZZ2
Assembly Note
These assemblies are ESD sensitive, ESD precautions shall be observed.

ZZ3
Assembly Note
These assemblies must be clean and free from flux and all contaminants. Use of no clean flux is not acceptable.

ZZ4
Assembly Note
These assemblies must comply with workmanship standards IPC-A-610 Class 2, unless otherwise specified.

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Number: TIDA-00332	Rev: E1	Designed for: Public Release	Mod. Date: 19/09/2014
SVN Rev: Not in version control	Assembly Variant: [No Variations]	Project Title: High Voltage Current Sense	Sheet: 3 of 3
Drawn By:	File: 340V_INA138_Hardware.SchDoc	Sheet Title: Hardware	Size: B
Engineer: Ed Mullins	Contact: http://www.ti.com/support	 TEXAS INSTRUMENTS http://www.ti.com © Texas Instruments 2014	

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